

## Features

- P-Channel, -5V Logic Level Control
- Enhancement mode
- Low on-resistance  $R_{DS(on)}$  @  $V_{GS}=-4.5V$
- Fast Switching
- Pb-free lead plating; RoHS compliant; Halogen Free

|                                 |      |    |
|---------------------------------|------|----|
| $V_{DS}$                        | -40  | V  |
| $R_{DS(on),max} @ V_{GS}=-10V$  | 29   | mΩ |
| $R_{DS(on),max} @ V_{GS}=-4.5V$ | 44   | mΩ |
| $I_D$                           | -5.5 | A  |


**Halogen-Free**
**SOT23-6L**

**Drain Pin1,2,5,6**


| Part ID  | Package Type | Marking | Tape and reel information |
|----------|--------------|---------|---------------------------|
| VS4518AH | SOT23-6L     | VS11    | 3000pcs/reel              |

## Maximum ratings, at $T_J = 25^\circ\text{C}$ , unless otherwise specified

| Symbol        | Parameter                                | Rating                            | Unit             |
|---------------|------------------------------------------|-----------------------------------|------------------|
| $V_{(BR)DSS}$ | Drain-Source breakdown voltage           | -40                               | V                |
| $I_S$         | Diode continuous forward current         | $T_A = 25^\circ\text{C}$<br>-1    | A                |
| $I_D$         | Continuous drain current @ $V_{GS}=-10V$ | $T_A = 25^\circ\text{C}$<br>-5.5  | A                |
|               |                                          | $T_A = 100^\circ\text{C}$<br>-3.4 | A                |
| $I_{DM}$      | Pulse drain current tested ①             | $T_A = 25^\circ\text{C}$<br>-22   | A                |
| $P_D$         | Maximum power dissipation                | $T_A = 25^\circ\text{C}$<br>1.25  | W                |
| $V_{GS}$      | Gate-Source voltage                      | $\pm 20$                          | V                |
| $T_{STG} T_J$ | Storage and operating temperature range  | -55 to 150                        | $^\circ\text{C}$ |

## Thermal Characteristics

| Symbol          | Parameter                               | Typical | Unit               |
|-----------------|-----------------------------------------|---------|--------------------|
| $R_{\theta JL}$ | Thermal Resistance, Junction to Lead    | 60      | $^\circ\text{C/W}$ |
| $R_{\theta JA}$ | Thermal Resistance, Junction to Ambient | 100     | $^\circ\text{C/W}$ |

## Typical Electrical Characteristics

| Symbol                                                                               | Parameter                                              | Condition                                                                                       | Min. | Typ. | Max. | Unit |
|--------------------------------------------------------------------------------------|--------------------------------------------------------|-------------------------------------------------------------------------------------------------|------|------|------|------|
| Static Electrical Characteristics @ T <sub>j</sub> = 25°C (unless otherwise stated)  |                                                        |                                                                                                 |      |      |      |      |
| V <sub>(BR)DSS</sub>                                                                 | Drain-Source Breakdown Voltage                         | V <sub>GS</sub> =0V, I <sub>D</sub> =-250μA                                                     | -40  | --   | --   | V    |
| I <sub>DSS</sub>                                                                     | Zero Gate Voltage Drain Current(T <sub>j</sub> =25°C)  | V <sub>DS</sub> =-40V,V <sub>GS</sub> =0V                                                       | --   | --   | 1    | μA   |
|                                                                                      | Zero Gate Voltage Drain Current(T <sub>j</sub> =125°C) | V <sub>DS</sub> =-40V,V <sub>GS</sub> =0V                                                       | --   | --   | 100  | μA   |
| I <sub>GSS</sub>                                                                     | Gate-Body Leakage Current                              | V <sub>GS</sub> =±20V,V <sub>DS</sub> =0V                                                       | --   | --   | ±100 | nA   |
| V <sub>GS(TH)</sub>                                                                  | Gate Threshold Voltage                                 | V <sub>DS</sub> =V <sub>GS</sub> ,I <sub>D</sub> =-250μA                                        | -1.3 | -1.9 | -2.4 | V    |
| R <sub>DS(ON)</sub>                                                                  | Drain-Source On-State Resistance②                      | V <sub>GS</sub> =-10V, I <sub>D</sub> =-4A                                                      | --   | 29   | 38   | mΩ   |
|                                                                                      |                                                        | V <sub>GS</sub> =-4.5V, I <sub>D</sub> =-3A                                                     | --   | 44   | 57   | mΩ   |
| Dynamic Electrical Characteristics @ T <sub>j</sub> = 25°C (unless otherwise stated) |                                                        |                                                                                                 |      |      |      |      |
| C <sub>iss</sub>                                                                     | Input Capacitance                                      | V <sub>DS</sub> =-20V,V <sub>GS</sub> =0V,<br>f=1MHz                                            | 1000 | 1310 | 1600 | pF   |
| C <sub>oss</sub>                                                                     | Output Capacitance                                     |                                                                                                 | 60   | 115  | 170  | pF   |
| C <sub>rss</sub>                                                                     | Reverse Transfer Capacitance                           |                                                                                                 | 40   | 90   | 140  | pF   |
| R <sub>g</sub>                                                                       | Gate Resistance                                        | f=1MHz                                                                                          | --   | 10   | --   | Ω    |
| Q <sub>g</sub>                                                                       | Total Gate Charge                                      | V <sub>DS</sub> =-20V,I <sub>D</sub> =-4A,<br>V <sub>GS</sub> =-10V                             | --   | 30   | --   | nC   |
| Q <sub>gs</sub>                                                                      | Gate-Source Charge                                     |                                                                                                 | --   | 4    | --   | nC   |
| Q <sub>gd</sub>                                                                      | Gate-Drain Charge                                      |                                                                                                 | --   | 6    | --   | nC   |
| Switching Characteristics                                                            |                                                        |                                                                                                 |      |      |      |      |
| t <sub>d(on)</sub>                                                                   | Turn-on Delay Time                                     | V <sub>DD</sub> =-20 V,<br>I <sub>D</sub> =-4A,<br>R <sub>G</sub> =3Ω,<br>V <sub>GS</sub> =-10V | --   | 9    | --   | nS   |
| t <sub>r</sub>                                                                       | Turn-on Rise Time                                      |                                                                                                 | --   | 7    | --   | nS   |
| t <sub>d(off)</sub>                                                                  | Turn-Off Delay Time                                    |                                                                                                 | --   | 192  | --   | nS   |
| t <sub>f</sub>                                                                       | Turn-Off Fall Time                                     |                                                                                                 | --   | 64   | --   | nS   |
| Source- Drain Diode Characteristics@ T <sub>j</sub> = 25°C (unless otherwise stated) |                                                        |                                                                                                 |      |      |      |      |
| V <sub>SD</sub>                                                                      | Forward on voltage                                     | I <sub>SD</sub> =-4A,V <sub>GS</sub> =0V                                                        | --   | -0.8 | -1.2 | V    |
| t <sub>rr</sub>                                                                      | Reverse Recovery Time                                  | T <sub>j</sub> =25°C,I <sub>SD</sub> =-4A,<br>V <sub>GS</sub> =0V                               | --   | 17   | --   | nS   |
| Q <sub>rr</sub>                                                                      | Reverse Recovery Charge                                | di/dt=-100A/μs                                                                                  |      | 7    |      | nC   |

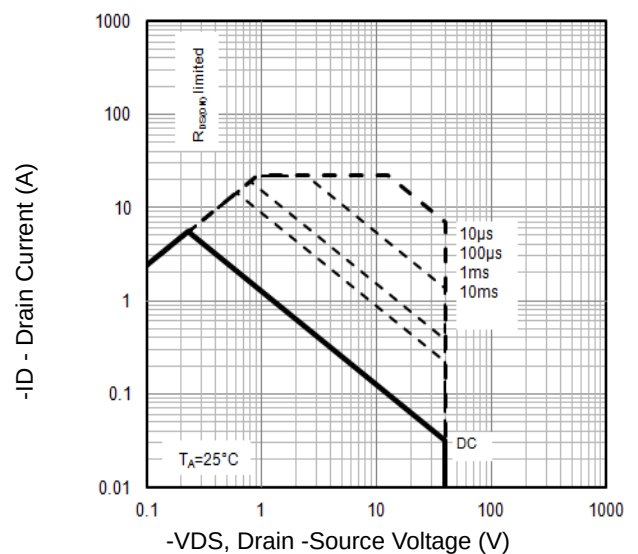
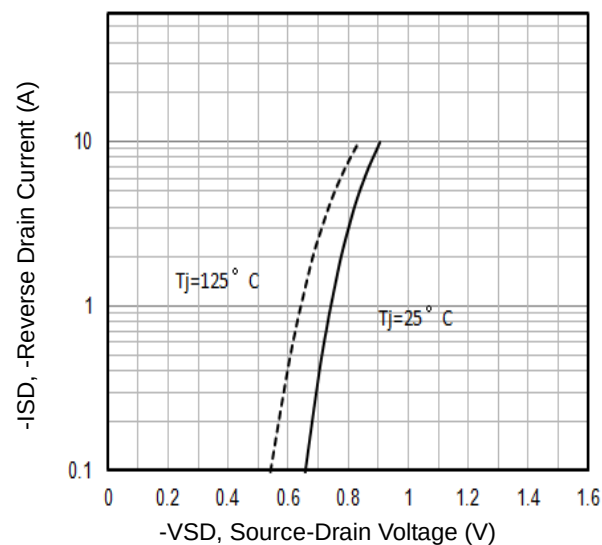
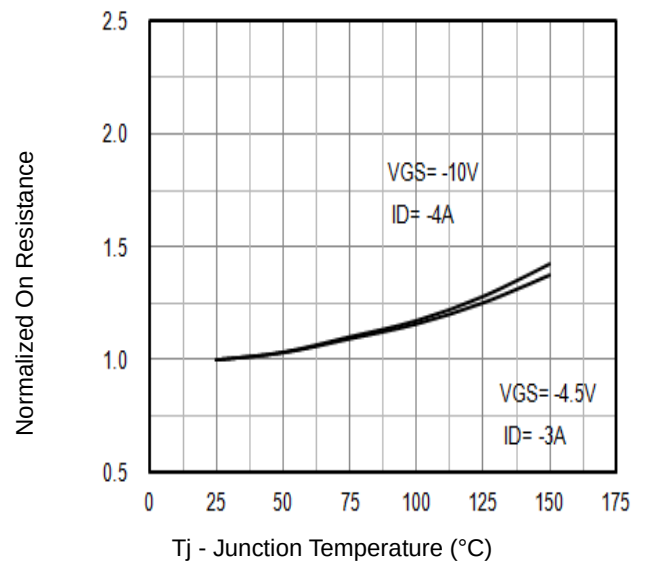
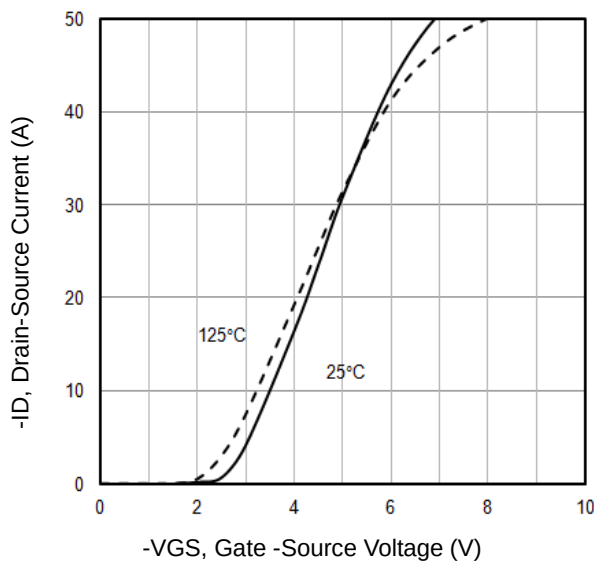
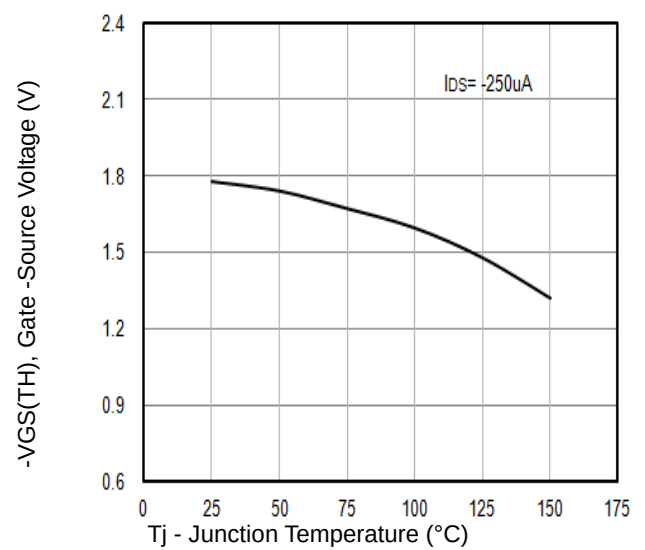
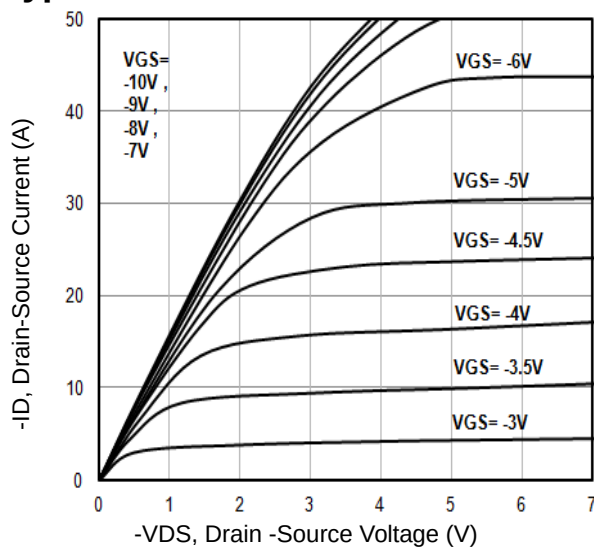
NOTE:

① Repetitive rating; pulse width limited by max. junction temperature.

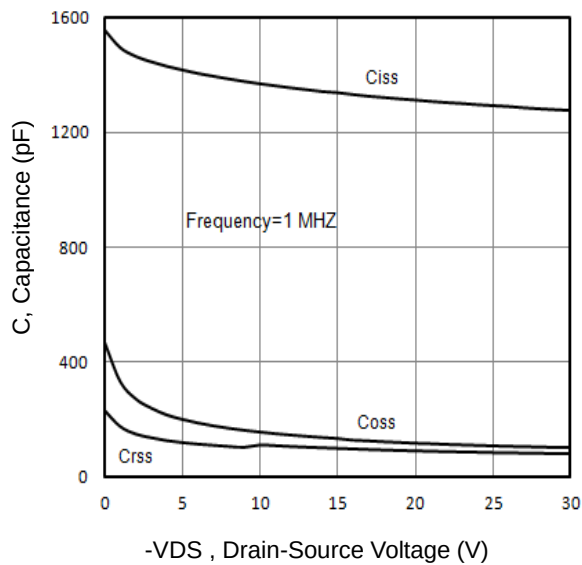
② Pulse width  $\leq 300\mu s$ ; duty cycles  $\leq 2\%$ .



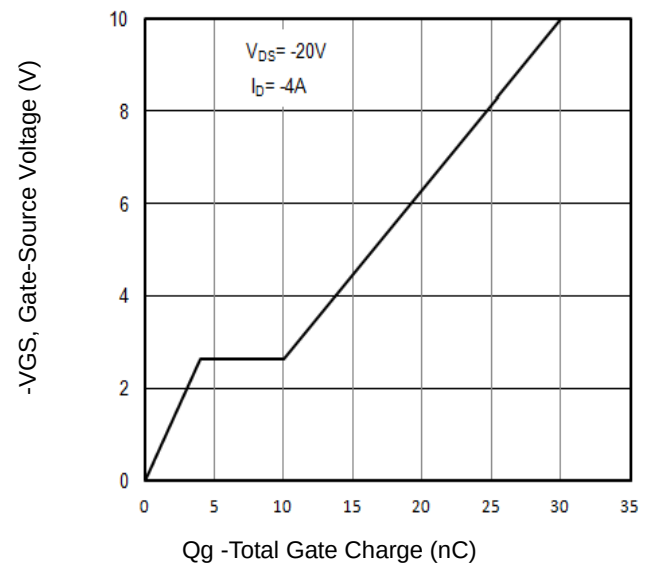
## Typical Characteristics



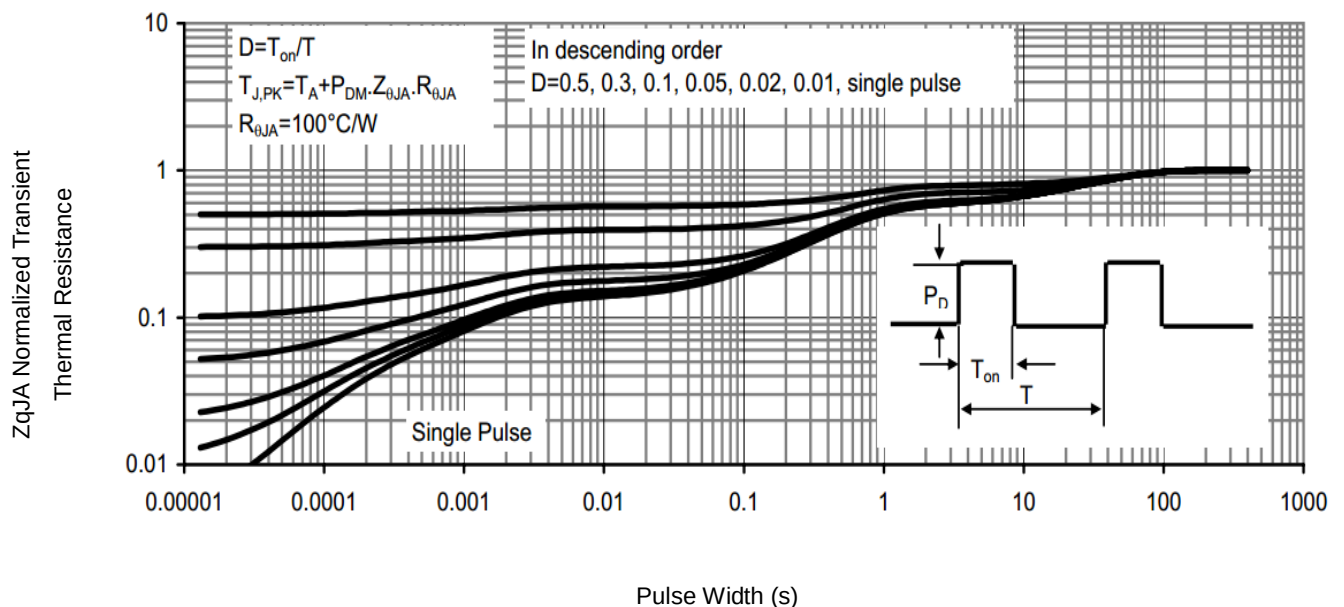
## Typical Characteristics



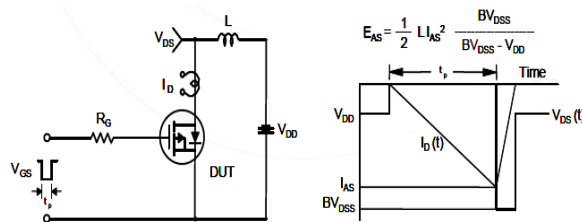
**Fig7.** Typical Capacitance Vs. Drain-Source Voltage



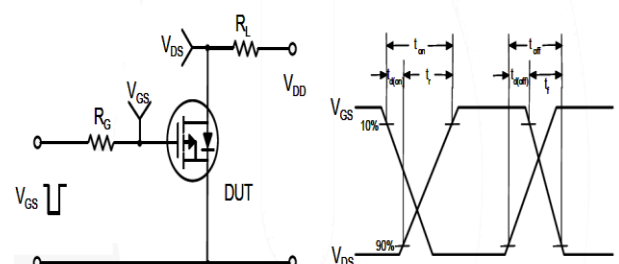
**Fig8.** Typical Gate Charge Vs. Gate-Source Voltage



**Fig9.** Normalized Maximum Transient Thermal Impedance

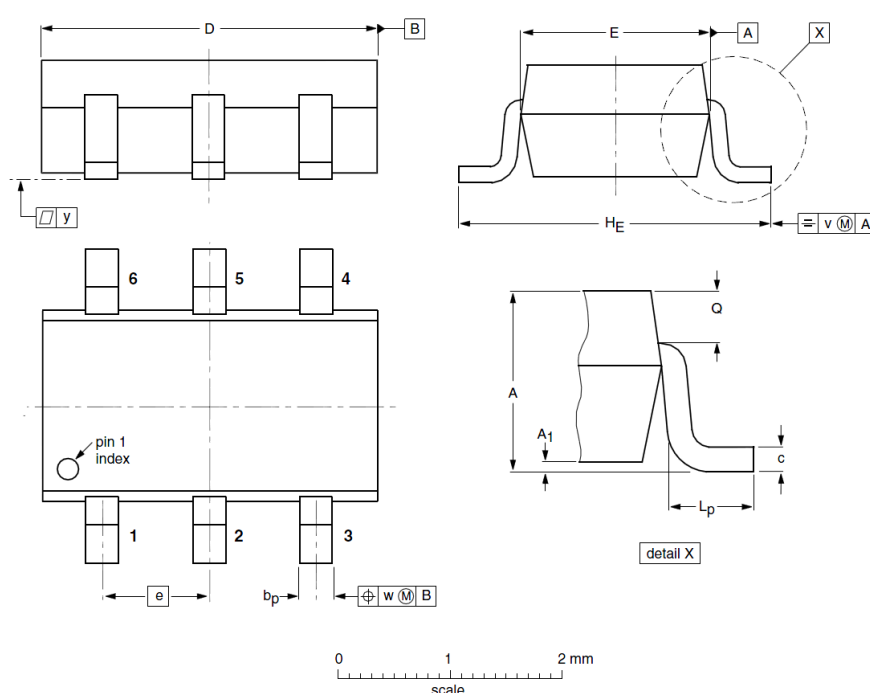


**Fig10.** Unclamped Inductive Test Circuit and waveforms



**Fig11.** Switching Time Test Circuit and waveforms

## SOT23-6L Package Outline



| Label                | Dimensions (unit: mm) |      |      |
|----------------------|-----------------------|------|------|
|                      | Min                   | Typ  | Max  |
| <b>A</b>             | 0.90                  | 1.07 | 1.45 |
| <b>b<sub>p</sub></b> | 0.30                  | 0.35 | 0.40 |
| <b>D</b>             | 2.70                  | 2.92 | 3.10 |
| <b>e</b>             | --                    | 0.95 | --   |
| <b>L<sub>p</sub></b> | 0.30                  | 0.45 | 0.60 |
| <b>v</b>             | --                    | 0.20 | --   |
| <b>y</b>             | --                    | 0.10 | --   |
| <b>A<sub>1</sub></b> | 0.01                  | 0.05 | 0.15 |
| <b>c</b>             | 0.10                  | 0.15 | 0.22 |
| <b>E</b>             | 1.30                  | 1.55 | 1.70 |
| <b>H<sub>E</sub></b> | 2.50                  | 2.80 | 3.00 |
| <b>Q</b>             | 0.23                  | 0.29 | 0.33 |
| <b>w</b>             | --                    | 0.20 | --   |

### Notes:

1. Follow JEDEC MS-012.
2. Dimension "D" does NOT include mold flash, protrusions or gate burrs. Mold flash, protrusions or gate burrs shall not exceed 0.15mm per side.
3. Dimension "E" does NOT include interlead flash or protrusion. Interlead flash or protrusion shall not exceed 0.25mm per side.
4. Dimension "bp" does NOT include dambar protrusion. Allowable dambar protrusion shall be 0.1mm total in excess of "bp" dimension at maximum material condition. The dambar cannot be located on the lower radius of the foot.

## Customer Service

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